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# **5V ECL Quint Differential Line Receiver**

#### Description

The MC10E416/100E416 is a 5-bit differential line receiving device. The 2.0 GHz of bandwidth provided by the high frequency outputs makes the device ideal for buffering of very high speed oscillators.

The design incorporates two stages of gain, internal to the device, making it an excellent choice for use in high bandwidth amplifier applications.

The differential inputs have internal clamp structures which will force the Q output of a gate in an open input condition to go to a LOW state. Thus, inputs of unused gates can be left open and will not affect the operation of the rest of the device. Note that the input clamp will take affect only if both inputs fall 2.5 V below  $V_{\rm CC}$ .

The  $V_{BB}$  pin, an internally generated voltage supply, is available to this device only. For single-ended input conditions, the unused differential input is connected to  $V_{BB}$  as a switching reference voltage.  $V_{BB}$  may also rebias AC coupled inputs. When used, decouple  $V_{BB}$  and  $V_{CC}$  via a  $0.01~\mu F$  capacitor and limit current sourcing or sinking to 0.5~mA. When not used,  $V_{BB}$  should be left open.

The 100 Series contains temperature compensation.

#### **Features**

- Differential D and Q; V<sub>BB</sub> available
- 600 ps Max. Propagation Delay
- High Frequency Outputs
- 2 Stages of Gain
- PECL Mode Operating Range: V<sub>CC</sub> = 4.2 V to 5.7 V with V<sub>EE</sub> = 0 V
- NECL Mode Operating Range: V<sub>CC</sub> = 0 V with V<sub>EE</sub> = -4.2 V to -5.7 V
- Internal Input 50 kΩ Pulldown Resistors
- ESD Protection: Human Body Model; > 2 kV, Machine Model; > 200 V
- Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test
- Moisture Sensitivity Level:

Pb = 1; Pb-Free = 3

For Additional Information, see Application Note AND8003/D

• Flammability Rating: UL 94 V–0 @ 0.125 in,

Oxygen Index: 28 to 34

- Transistor Count = 201 devices
- Pb-Free Packages are Available\*



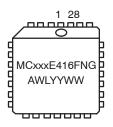
# ON Semiconductor®

http://onsemi.com



PLCC-28 FN SUFFIX CASE 776

#### **MARKING DIAGRAM\***



xxx = 10 or 100

A = Assembly Location

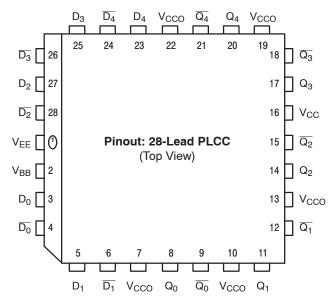
WL = Wafer Lot
 YY = Year
 WW = Work Week
 G = Pb-Free Package

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

<sup>\*</sup>For additional marking information, refer to Application Note AND8002/D.



\* All  $V_{CC}$  and  $V_{CCO}$  pins are tied together on the die. Warning: All  $V_{CC}$ ,  $V_{CCO}$ , and  $V_{EE}$  pins must be externally connected to Power Supply to guarantee proper operation.

Figure 1. 28-Lean Pinout Assignment

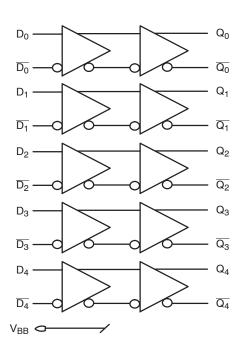


Figure 2. Logic Diagram

**Table 1. PIN DESCRIPTION** 

PIN	FUNCTION
D[0:4], $\overline{D}$ [0:4]	ECL Differential Data Inputs
Q[0:4], \( \overline{Q}[0:4]	ECL Differential Data Outputs
V <sub>BB</sub>	Reference Voltage Output
V <sub>CC</sub> , V <sub>CCO</sub>	Positive Supply
V <sub>EE</sub>	Negative Supply

**Table 2. MAXIMUM RATINGS** 

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V <sub>CC</sub>	PECL Mode Power Supply	V <sub>EE</sub> = 0 V		8	V
VI	PECL Mode Input Voltage NECL Mode Input Voltage	V <sub>EE</sub> = 0 V V <sub>CC</sub> = 0 V	$V_{I} \leq V_{CC}$ $V_{I} \geq V_{EE}$	6 -6	V V
l <sub>out</sub>	Output Current	Continuous Surge		50 100	mA mA
I <sub>BB</sub>	V <sub>BB</sub> Sink/Source			± 0.5	mA
T <sub>A</sub>	Operating Temperature Range			0 to +85	°C
T <sub>stg</sub>	Storage Temperature Range			-65 to +150	°C
θЈА	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	PLCC-28 PLCC-28	63.5 43.5	°C/W
$\theta_{JC}$	Thermal Resistance (Junction-to-Case)	Standard Board	PLCC-28	22 to 26	°C/W
T <sub>sol</sub>	Wave Solder Pb Pb-Free			265 265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 3. 10E SERIES PECL DC CHARACTERISTICS V<sub>CCx</sub> = 5.0 V, V<sub>EE</sub> = 0.0 V (Note 1)

			0°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current		135	162		135	162		135	162	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 2)	3980	4070	4160	4020	4105	4190	4090	4185	4280	mV
V <sub>OL</sub>	Output LOW Voltage (Note 2)	3050	3210	3370	3050	3210	3370	3050	3227	3405	mV
V <sub>IH</sub>	Input HIGH Voltage (Single-Ended)	3830	3995	4160	3870	4030	4190	3940	4110	4280	mV
V <sub>IL</sub>	Input LOW Voltage (Single-Ended)	3050	3285	3520	3050	3285	3520	3050	3302	3555	mV
V <sub>BB</sub>	Output Voltage Reference	3.62		3.73	3.65		3.75	3.69		3.81	V
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 3)	2.7		5.0	2.7		5.0	2.7		5.0	V
I <sub>IH</sub>	Input HIGH Current			150			150			150	μΑ
I <sub>IL</sub>	Input LOW Current	0.5	0.3		0.5	0.25		0.3	0.2		μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 1. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary -0.46~V / +0.06~V.
- 2. Outputs are terminated through a 50  $\Omega$  resistor to  $V_{CC}$  2.0 V. 3.  $V_{IHCMR}$  min varies 1:1 with  $V_{EE}$ , max varies 1:1 with  $V_{CC}$ .

Table 4. 10E SERIES NECL DC CHARACTERISTICS V<sub>CCx</sub> = 0.0 V; V<sub>EE</sub> = -5.0 V (Note 4)

			0°C			25°C			85°C			
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit	
I <sub>EE</sub>	Power Supply Current		135	162		135	162		135	162	mA	
V <sub>OH</sub>	Output HIGH Voltage (Note 5)	-1020	-930	-840	-980	-895	-810	-910	-815	-720	mV	
V <sub>OL</sub>	Output LOW Voltage (Note 5)	-1950	-1790	-1630	-1950	-1790	-1630	-1950	-1773	-1595	mV	
V <sub>IH</sub>	Input HIGH Voltage (Single-Ended)	-1170	-1005	-840	-1130	-970	-810	-1060	-890	-720	mV	
V <sub>IL</sub>	Input LOW Voltage (Single-Ended)	-1950	-1715	-1480	-1950	-1715	-1480	-1950	-1698	-1445	mV	
$V_{BB}$	Output Voltage Reference	-1.38		-1.27	-1.35		-1.25	-1.31		-1.19	V	
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 6)	-2.3		0.0	-2.3		0.0	-2.3		0.0	٧	
I <sub>IH</sub>	Input HIGH Current	1		150			150			150	μΑ	
I <sub>IL</sub>	Input LOW Current	0.5	0.3		0.5	0.065		0.3	0.2		μΑ	

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 4. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary -0.46~V / +0.06~V.
- 5. Outputs are terminated through a 50  $\Omega$  resistor to  $V_{CC}$  2.0 V.
- 6.  $V_{IHCMR}$  min varies 1:1 with  $V_{EE}$ , max varies 1:1 with  $V_{CC}$ .

Table 5. 100E SERIES PECL DC CHARACTERISTICS V<sub>CCx</sub> = 5.0 V; V<sub>EE</sub> = 0.0 V (Note 7)

			0°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current		135	162		135	162		155	186	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 8)	3975	4050	4120	3975	4050	4120	3975	4050	4120	mV
V <sub>OL</sub>	Output LOW Voltage (Note 8)	3190	3295	3380	3190	3255	3380	3190	3260	3380	mV
V <sub>IH</sub>	Input HIGH Voltage (Single-Ended)	3835	3975	4120	3835	3975	4120	3835	3975	4120	mV
V <sub>IL</sub>	Input LOW Voltage (Single-Ended)	3190	3355	3525	3190	3355	3525	3190	3355	3525	mV
V <sub>BB</sub>	Output Voltage Reference	3.62		3.74	3.62		3.74	3.62		3.74	V
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 9)	2.7		5.0	2.7		5.0	2.7		5.0	V
I <sub>IH</sub>	Input HIGH Current			150			150			150	μΑ
I <sub>IL</sub>	Input LOW Current	0.5	0.3		0.5	0.25		0.5	0.2		μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 7. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary -0.46~V / +0.8~V.
- 8. Outputs are terminated through a 50  $\Omega$  resistor to  $V_{CC}$  2.0 V. 9.  $V_{IHCMR}$  min varies 1:1 with  $V_{EE}$ , max varies 1:1 with  $V_{CC}$ .

Table 6. 100E SERIES NECL DC CHARACTERISTICS V<sub>CCx</sub> = 0 V; V<sub>EE</sub> = -5.0 V (Note 10)

			0°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current		135	162		135	162		155	186	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 11)	-1025	-950	-880	-1025	-950	-880	-1025	-950	-880	mV
V <sub>OL</sub>	Output LOW Voltage (Note 11)	-1810	-1705	-1620	-1810	-1745	-1620	-1810	-1740	-1620	mV
V <sub>IH</sub>	Input HIGH Voltage (Single-Ended)	-1165	-1025	-880	-1165	-1025	-880	-1165	-1025	-880	mV
V <sub>IL</sub>	Input LOW Voltage (Single-Ended)	-1810	-1645	-1475	-1810	-1645	-1475	-1810	-1645	-1475	mV
V <sub>BB</sub>	Output Voltage Reference	-1.38		-1.26	-1.38		-1.26	-1.38		-1.26	V
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 12)	-2.3		0.0	-2.3		0.0	-2.3		0.0	V
I <sub>IH</sub>	Input HIGH Current			150			150			150	μΑ
I <sub>IL</sub>	Input LOW Current	0.5	0.3		0.5	0.25		0.5	0.2		μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 10. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary -0.46~V / +0.8~V.
- 11. Outputs are terminated through a 50  $\Omega$  resistor to  $\overline{V}_{CC}$  2.0 V.
- 12. V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, max varies 1:1 with V<sub>CC</sub>.

Table 7. AC CHARACTERISTICS  $V_{CCx} = 5.0 \text{ V}$ ;  $V_{EE} = 0.0 \text{ V}$  or  $V_{CCx} = 0.0 \text{ V}$ ;  $V_{EE} = -5.0 \text{ V}$  (Note 13)

			0°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f <sub>MAX</sub>	Maximum Toggle Frequency					> 2.0					GHz
t <sub>PLH</sub>	Propagation Delay to Output										ps
t <sub>PHL</sub>	d(Diff)	250	350	500	250	350	500	250	350	500	
	D(SE)	200	350	550	200	350	550	200	350	550	
t <sub>SKEW</sub>	Within-Device Skew (Note 14)		50			50			50		ps
t <sub>SKEW</sub>	Duty Cycle Skew (Note 15) t <sub>PLH</sub> -t <sub>PHL</sub>		±10			±10			±10		ps
t <sub>JITTER</sub>	Random Clock Jitter (RMS)		< 1			< 1			< 1		ps
V <sub>PP</sub> (AC)	Input Voltage Swing (Differential Configuration)	150		1000	150		1000	150		1000	mV
t <sub>r</sub>	Rise/Fall Time										ps
t <sub>f</sub>	(20 - 80%)	100	200	350	100	200	350	100	200	350	

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

<sup>13.10</sup> Series:  $V_{EE}$  can vary -0.46 V / +0.06 V. 100 Series:  $V_{EE}$  can vary -0.46 V / +0.8 V.

<sup>14.</sup> Within-device skew is defined as identical transitions on similar paths through a device.

<sup>15.</sup> Duty cycle skew defined only for differential operation when the delays are measured from the cross point of the inputs to the cross point of the outputs.

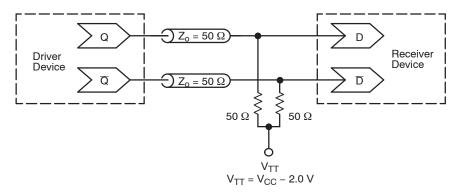


Figure 3. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020/D – Termination of ECL Logic Devices.)

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>				
MC10E416FN	PLCC-28	37 Units / Rail				
MC10E416FNG	PLCC-28 (Pb-Free)	37 Units / Rail				
MC10E416FNR2	PLCC-28	500 / Tape & Reel				
MC10E416FNR2G	PLCC-28 (Pb-Free)	500 / Tape & Reel				
MC100E416FN	PLCC-28	37 Units / Rail				
MC100E416FNG	PLCC-28 (Pb-Free)	37 Units / Rail				
MC100E416FNR2	PLCC-28	500 / Tape & Reel				
MC100E416FNR2G	PLCC-28 (Pb-Free)	500 / Tape & Reel				

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

### **Resource Reference of Application Notes**

AN1405/D - ECL Clock Distribution Techniques

AN1406/D - Designing with PECL (ECL at +5.0 V)

AN1503/D - ECLinPS™ I/O SPiCE Modeling Kit

AN1504/D - Metastability and the ECLinPS Family

AN1568/D - Interfacing Between LVDS and ECL

AN1672/D - The ECL Translator Guide

AND8001/D - Odd Number Counters Design

AND8002/D - Marking and Date Codes

AND8020/D - Termination of ECL Logic Devices

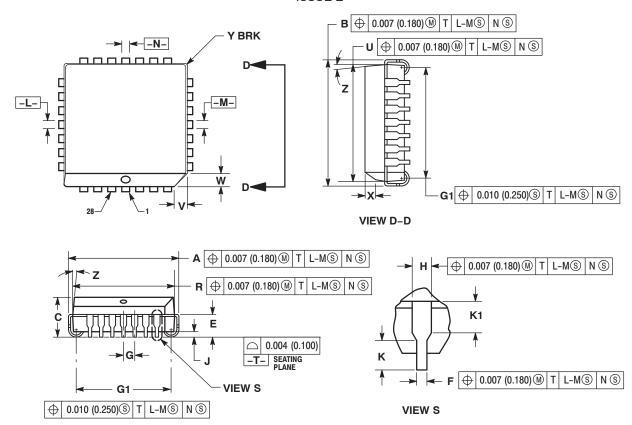
AND8066/D - Interfacing with ECLinPS

AND8090/D - AC Characteristics of ECL Devices

#### PACKAGE DIMENSIONS

#### PLCC-28 FN SUFFIX

PLASTIC PLCC PACKAGE CASE 776-02 ISSUE E



#### NOTES:

- DATUMS -L-, -M-, AND -N- DETERMINED
   WHERE TOP OF LEAD SHOULDER EXITS
   PLASTIC BODY AT MOLD PARTING LINE.
- PLASTIC BODY AT MOLD PARTING LINE.

  DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.

  DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- Unit (0.250) PER SIDE.
   DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 5. CONTROLLING DIMENSION: INCH.
  6. THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- PLASTIC BOUT.

  7. DIMENSION H DOES NOT INCLUDE DAMBAR
  PROTRUSION OR INTRUSION. THE DAMBAR
  PROTRUSION(S) SHALL NOT CAUSE THE H
  DIMENSION TO BE GREATER THAN 0.037
  (0.940). THE DAMBAR INTRUSION(S) SHALL
  NOT CAUSE THE H DIMENSION TO BE
  SMALLER THAN 0.025 (0.635).

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.485	0.495	12.32	12.57
В	0.485	0.495	12.32	12.57
С	0.165	0.180	4.20	4.57
Е	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050	BSC	1.27	BSC
Н	0.026	0.032	0.66	0.81
J	0.020		0.51	
K	0.025		0.64	
R	0.450	0.456	11.43	11.58
U	0.450	0.456	11.43	11.58
٧	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
Х	0.042	0.056	1.07	1.42
Υ		0.020		0.50
Z	2 °	10°	2 °	10°
G1	0.410	0.430	10.42	10.92
K1	0.040		1.02	

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